Amendment Under 37 C.F.R. § 1.111

U.S.S.N.: 10/810,246

Page 3 of 8

IN THE CLAIMS:

Please cancel claims 7-19 without prejudice or disclaimer.

- 1. (Original) A semiconductor device, comprising:
- a semiconductor layer;
- a gate insulator layer formed on the semiconductor layer; and
- a gate electrode formed on the gate insulator layer, wherein the atomic ratio of oxygen atoms included in the gate insulator layer is 5 atm. % or below.
 - 2. (Original) A semiconductor device, comprising:
 - a semiconductor layer;
 - a gate insulator layer formed on the semiconductor layer and having an interface reaction layer; and
- a gate electrode formed on the gate insulator layer, wherein the atomic ratio of oxygen atoms included in the gate insulator layer is approximately 5 atm. % or below.
- 3. (Original) The semiconductor device according to Claim 1 or 2, wherein the gate insulator layer is a silicon nitride layer.
- 4. (Original) The semiconductor device according to Claim 3, wherein the silicon nitride layer is formed by the reaction of a nitrogen species activated by plasma excitation directly with the semiconductor layer.
- 5. (Original) The semiconductor device according to any one of Claims 1, 2, or 4, wherein the gate electrode includes a tantalum nitride layer.
- 6. (Original) The semiconductor device according to Claim 5, wherein the tantalum nitride layer is formed by sputtering.

Amendment Under 37 C.F.R. § 1.111

U.S.S.N.: 10/810,246

Page 4 of 8

Claims 7-19 (Cancelled).

20. (New) A semiconductor device, comprising:

a semiconductor layer;

a gate insulator layer formed on the semiconductor layer; and

a gate electrode formed on the gate insulator layer, wherein the atomic ratio of oxygen atoms included in the entire gate insulator layer is 5 atm. % or below.

21. (New) A semiconductor device, comprising:

a semiconductor layer;

a gate insulator layer formed on the semiconductor layer, wherein the gate insulator layer does not include an interface reaction layer including oxygen at an interface with the gate electrode; and

a gate electrode formed on the gate insulator layer, wherein the atomic ratio of oxygen atoms included in the gate insulator layer is 5 atm. % or below.